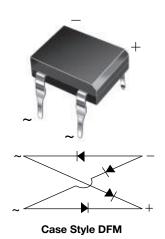
Vishay General Semiconductor

Miniature Glass Passivated Ultrafast Bridge Rectifier



LINKS TO ADDITIONAL RESOURCES



| PRIMARY CHARACTERISTICS | | | | | | |
|-------------------------|---------------------------|--|--|--|--|--|
| I _{F(AV)} | 1 A | | | | | |
| V _{RRM} | 50 V, 100 V, 150 V, 200 V | | | | | |
| I _{FSM} | 50 A | | | | | |
| I _R | 5 μΑ | | | | | |
| V_F at $I_F = 1.0$ A | 1.05 V | | | | | |
| t _{rr} | 50 ns | | | | | |
| T _J max. | 150 °C | | | | | |
| Package | DFM | | | | | |
| Circuit configuration | Quad | | | | | |

FEATURES

• UL recognition, file number E54214

• Ideal for printed circuit boards



Ultrafast reverse recovery time for high frequency

- Applicable for automated insertion
- · High surge current capability
- Solder dip 275 °C max. 10 s, per JESD 22-B106
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

TYPICAL APPLICATIONS

General purpose use in AC/DC bridge full wave rectification for SMPS, lighting ballaster, adapter, battery charger, home appliances, office equipment, and telecommunication applications.

MECHANICAL DATA

Case: DFM

Molding compound meets UL 94 V-0 flammability rating Base P/N-E3 - RoHS-compliant, commercial grade

Terminals: matte tin plated leads, solderable per

J-STD-002 and JESD 22-B102

E3 suffix meets JESD 201 class 1A whisker test

Polarity: as marked on body

| MAXIMUM RATINGS (T _A = 25 °C unless otherwise noted) | | | | | | |
|--|-----------------------------------|-------------|--------|--------|------------------|------|
| PARAMETER | SYMBOL | EDF1AM | EDF1BM | EDF1CM | EDF1DM | UNIT |
| Maximum repetitive peak reverse voltage | V_{RRM} | 50 | 100 | 150 | 200 | V |
| Maximum RMS voltage | V_{RMS} | 35 | 70 | 106 | 140 | V |
| Maximum DC blocking voltage | V_{DC} | 50 | 100 | 150 | 200 | V |
| Maximum average forward output rectified current at T _A = 40 °C | I _{F(AV)} | 1.0 | | | Α | |
| Peak forward surge current single sine-wave superimposed on rated load | I _{FSM} | 50 | | | Α | |
| Rating for fusing (t < 8.3 ms) | l ² t | 10 | | | A ² s | |
| Operating junction and storage temperature range | T _J , T _{STG} | -55 to +150 | | | °C | |



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| ELECTRICAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted) | | | | | | | | |
|---|--|-----------------|--------|--------|--------|--------|------|--|
| PARAMETER | TEST CONDITIONS | SYMBOL | EDF1AM | EDF1BM | EDF1CM | EDF1DM | UNIT | |
| Maximum instantaneous forward voltage drop per diode | 1.0 A | V _F | 1.05 | | | V | | |
| Maximum reverse current at rated DC blocking voltage per diode | T _A = 25 °C | | | 5.0 |) | | μA | |
| | T _A = 125 °C | IR | 1.0 | | | | mA | |
| Maximum reverse recovery time per diode | $I_F = 0.5 A, I_R = 1.0 A,$ $I_{rr} = 0.25 A$ | t _{rr} | 50 | | | ns | | |

| THERMAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted) | | | | | | | |
|---|-----------------|--------|--------|--------|--------|------|--|
| PARAMETER | SYMBOL | EDF1AM | EDF1BM | EDF1CM | EDF1DM | UNIT | |
| Typical thermal resistance (1) | $R_{\theta JA}$ | 38 | | | | | |
| Typical trieffilal resistance (**) | $R_{	heta JL}$ | 12 | | | | °C/W | |

Note

⁽¹⁾ Thermal resistance from junction to ambient and from junction to lead mounted on PCB with 0.5" x 0.5" (13 mm x 13 mm) copper pads

| ORDERING INFORMATION (Example) | | | | | | | |
|--------------------------------|-----------------|------------------------|---------------|---------------|--|--|--|
| PREFERRED P/N | UNIT WEIGHT (g) | PREFERRED PACKAGE CODE | BASE QUANTITY | DELIVERY MODE | | | |
| EDF1DM-E3/45 | 0.418 | 45 | 50 | Tube | | | |

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RATINGS AND CHARACTERISTICS CURVES (T_A = 25 °C unless otherwise noted)

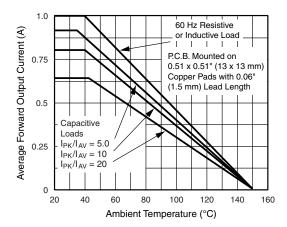


Fig. 1 - Derating Curves Output Rectified Current

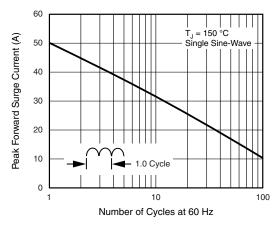


Fig. 2 - Maximum Non-Repetitive Peak Forward Surge Current Per Diode

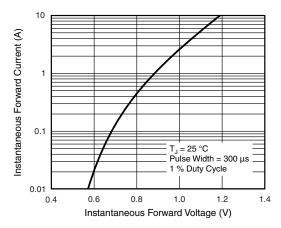


Fig. 3 - Typical Forward Characteristics Per Diode

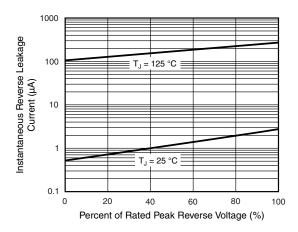


Fig. 4 - Typical Reverse Leakage Characteristics Per Diode

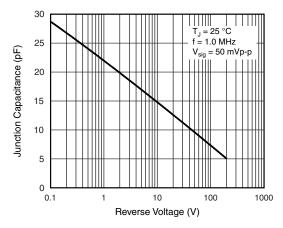
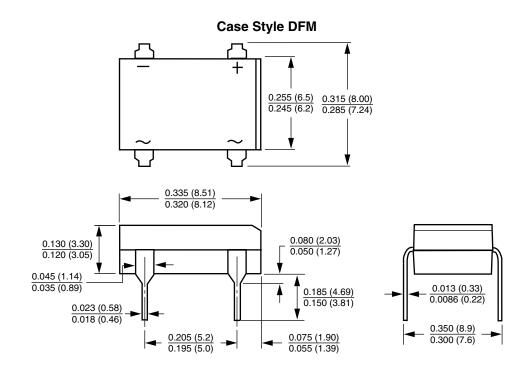


Fig. 5 - Typical Junction Capacitance Per Diode

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PACKAGE OUTLINE DIMENSIONS in inches (millimeters)



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